

IE-PCB-SPE-P-90V2.1-THR-YG/YG RL**Weidmüller Interface GmbH & Co. KG**

Klingenbergstraße 26

D-32758 Detmold

Germany

www.weidmueller.com**SPElink®****Single Pair Ethernet PCB sockets**

Single pair Ethernet is a technology that only requires one pair of wires to transmit data and power.

The resulting benefits will make SPE the preferred network at the field level and beyond.

Advantages of Single Pair Ethernet:

- Consistent: Single Pair Ethernet enables uniform Ethernet-based communication from the sensor to the cloud
- Future-proof: key technology for Industry 4.0 and IIoT
- Flexible: ranges of up to 1000 m and transmission properties of up to 1 Gbps enable use across applications
- Innovative: lighter, less space required, and reduced installation effort

General ordering data

Version	PCB plug-in connector, male header, SPE (Single Pair Ethernet), Clip-on flange, THT/THR solder connection, 1.80 mm, Number of poles: 2, 90°, Solder pin length (l): 2.1 mm, Ni/Au, black, Tape
Order No.	2795120000
Type	IE-PCB-SPE-P-90V2.1-THR-YG/YG RL
GTIN (EAN)	4064675119227
Qty.	100 pc(s).
Packaging	Tape

Creation date May 2, 2024 1:03:45 AM CEST

Catalogue status 20.04.2024 / We reserve the right to make technical changes.

IE-PCB-SPE-P-90V2.1-THR-YG/YG RL

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26

D-32758 Detmold

Germany

www.weidmueller.com

Technical data

Dimensions and weights

Depth	19.9 mm	Depth (inches)	0.783 inch
Height	10.9 mm	Height (inches)	0.429 inch
Width	7.52 mm	Width (inches)	0.296 inch
Net weight	5.93 g		

Temperatures

Operating temperature	-40 °C...85 °C
-----------------------	----------------

System specifications

Category	T1-B	LED	Yes
Mounting onto the PCB	THT/THR solder connection	Number of poles	2
Outgoing elbow	90°	Performance-Category	T1-B 10/100 MBit/s, 1000 MBit/s
Pitch in inches (P)	0.071 "	Pitch in mm (P)	1.8 mm
Plugging cycles	750	Plugging force/pole, max.	3.5 N
Plugging force/pole, min.	9.1 N	Product family	Industrial Ethernet
Protection degree	IP20	Pulling force / pole, min.	3.4 N
Pulling force/pole, max.	6.7 N	Shield surface	tinned
Shielding	Yes	Shielding material	CuSn
Side termination, characteristic	Clip-on flange	Solder pin dimensions	Octagonal
Solder pin length (l)	2.1 mm	Soldering process	Reflow soldering, Manual soldering, Wave soldering
Tolerance of solder pin position	± 0.1 mm	Transmission rate	10/100 MBit/s, 1000 MBit/s
Type of connection	Solder connection, Male contact		

Electrical properties

Dielectric strength, contact / contact	1000 V DC	Dielectric strength, contact / shield	2250 V DC
Insulation strength	≥ 500 MΩ	PoE / PoE+	PoDL acc. to IEEE 802.3bu / cg
Rated current	4 A	Rated voltage	72 V

Standards

Connector standard	IEC 63171-2
--------------------	-------------

Material data

Insulating material	LCP	Colour	black
Colour chart (similar)	RAL 9011	Insulation strength	≥ 500 MΩ
Moisture Level (MSL)	1	UL 94 flammability rating	V-0
Contact base material	CuMg	Contact material	Cu-alloy
Contact surface	Ni/Au	Layer structure of solder connection	2...4 µm Ni / ≥ 0.25 µm Au
Operating temperature, min.	-40 °C	Operating temperature, max.	85 °C

Packing

Packaging	Tape	VPE length	459 mm
VPE width	365 mm	VPE height	61 mm

IE-PCB-SPE-P-90V2.1-THR-YG/YG RL

Weidmüller Interface GmbH & Co. KG
Klingenbergstraße 26
D-32758 Detmold
Germany

www.weidmueller.com

Technical data

Classifications

ETIM 6.0	EC002637	ETIM 7.0	EC002637
ETIM 8.0	EC002637	ETIM 9.0	EC002637
ECLASS 9.0	27-44-04-02	ECLASS 9.1	27-44-04-02
ECLASS 10.0	27-44-04-02	ECLASS 11.0	27-46-02-01
ECLASS 12.0	27-46-02-01	ECLASS 13.0	27-46-02-01

Approvals

Approvals



ROHS	Conform
UL File Number Search	UL Website
Certificate No. (cURus)	E316369

Downloads

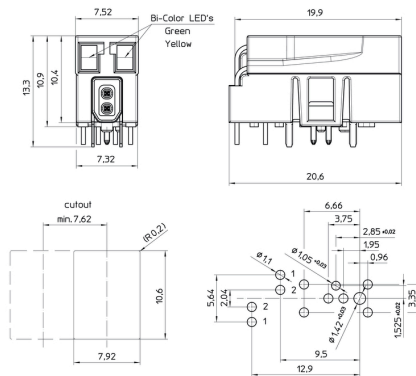
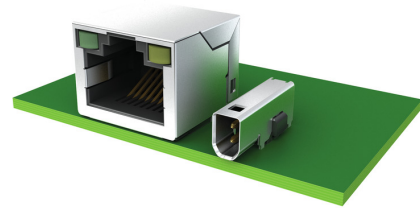
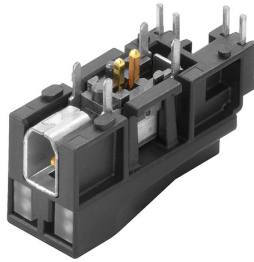
Engineering Data	CAD data – STEP
Product Change Notification	2022 1209 Änderung von SPE Typbezeichnung 2022 1209 Change of SPE type description
Technical Documentation	2795 120000 IE-PCB-SP0-P-90V-THR-YG/YG 2795 120000 IE-PCB-SP0-P-90V-THR-YG-YG_CD.pdf
Catalogues	Catalogues in PDF-format

IE-PCB-SPE-P-90V2.1-THR-YG/YG RL


Weidmüller Interface GmbH & Co. KG
 Klängenbergstraße 26
 D-32758 Detmold
 Germany

www.weidmueller.com

Drawings



Pin assignment

		
Pair	Contacts	Data
1	1	RX/TX+
	2	RX/TX-
effective length		
Contact 1	11.3	
Contact 2	15	

LED Polarity

Green
 2 - 1
 Yellow

LED- Specifications				
Bi-Color LED	Forward Voltage (Max)	Forward Voltage (Typ)	Wavelength	
Green/Yellow	Green 2.6 V	2.2 V	570 nm	
Yellow	2.6 V	2.1 V	590 nm	

* With a forward current of 20 mA (Typ)

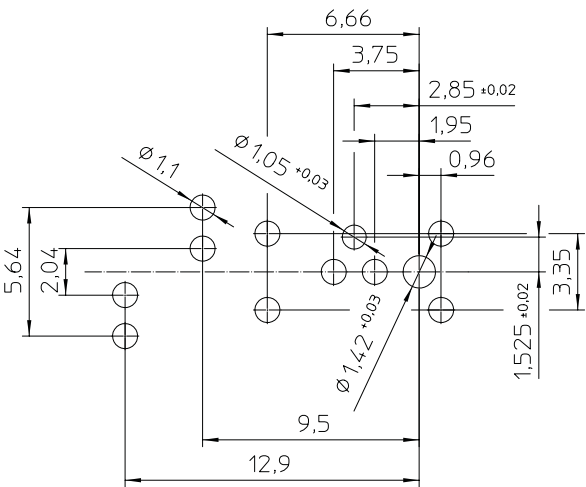
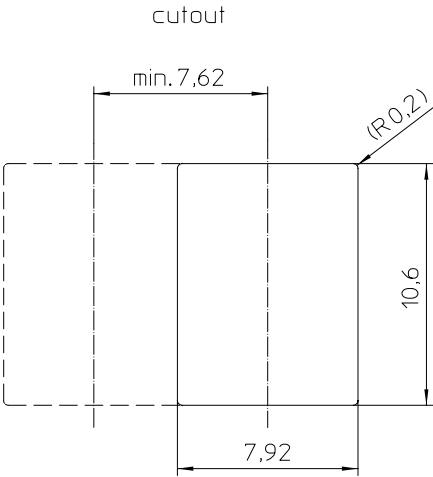
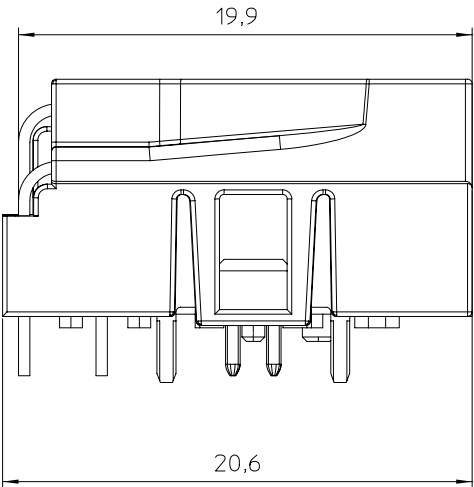
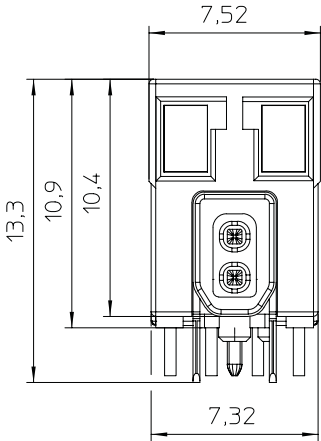
IE-PCB-SPE-P-90V2.1-THR-YG/YG RL

Weidmüller Interface GmbH & Co. KG
Klingenbergstraße 26
D-32758 Detmold
Germany

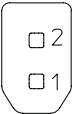
www.weidmueller.com

Drawings

2795120000 IE-PCB-SP0-P-90V-THR-YG/YG



Pin assignment

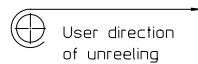
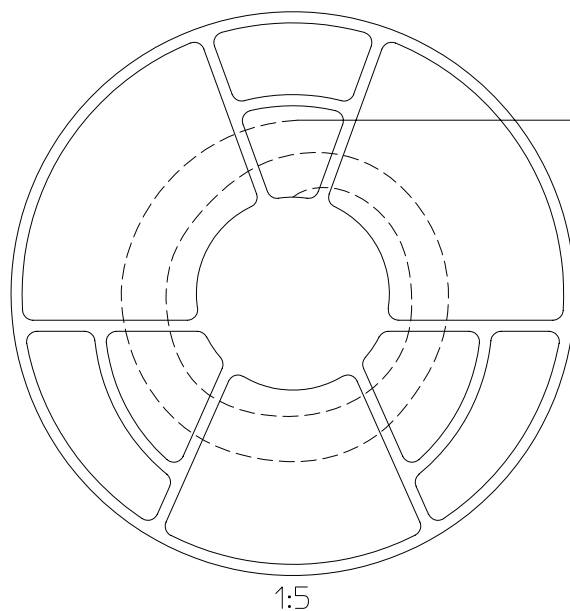


Pair	Contacts	Data
1	1	RX/TX+
	2	RX/TX-

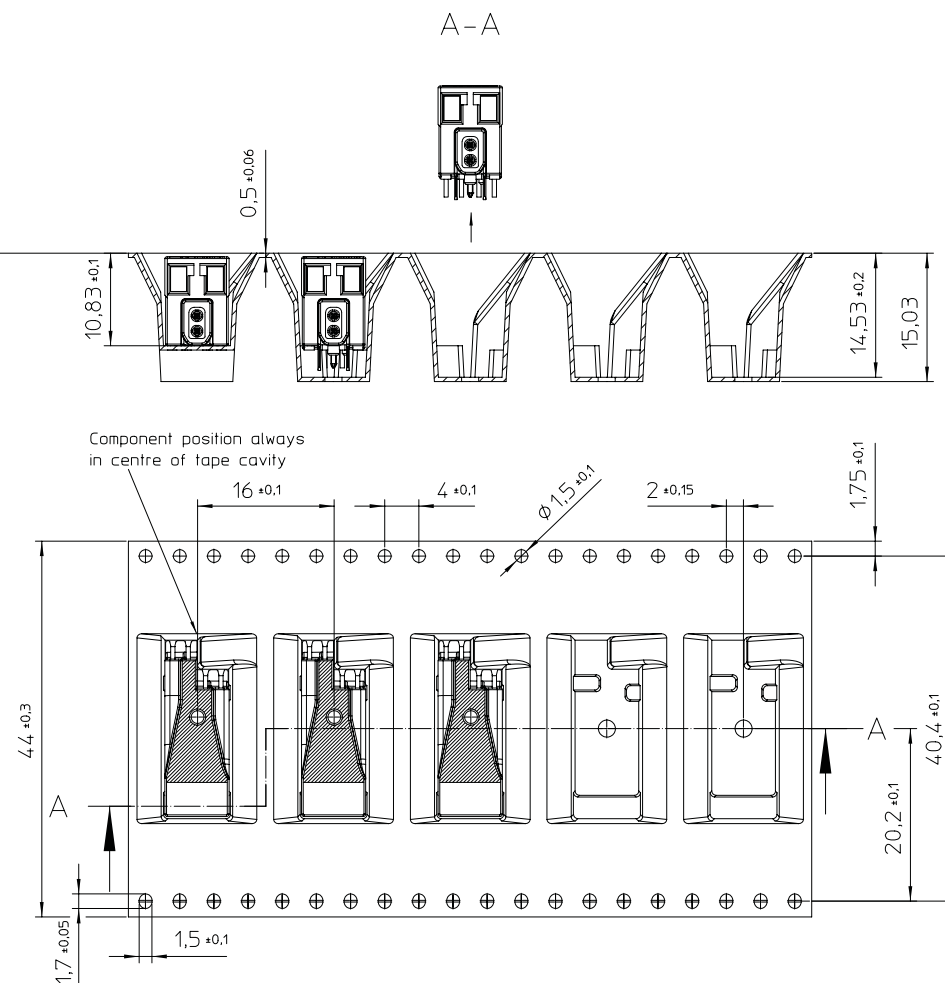
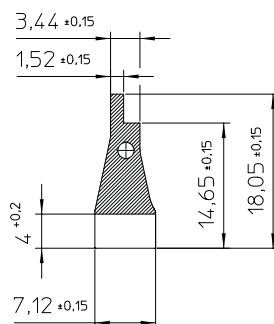
	effective length
Contact 1	11,3
Contact 2	15

2795120000 IE-PCB-SP0-P-90V-THR-YG/YG

Spool width: 50,4

User direction
of unreeling

possible suction area



Recommended wave soldering profiles

Weidmüller Interface GmbH & Co. KG
Klingenbergstraße 16
D-32758 Detmold
Germany
Fon: +49 5231 14-0
Fax: +49 5231 14-292083
www.weidmueller.com

Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

We reserve the right to make technical changes.

Recommended reflow soldering profile

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 16

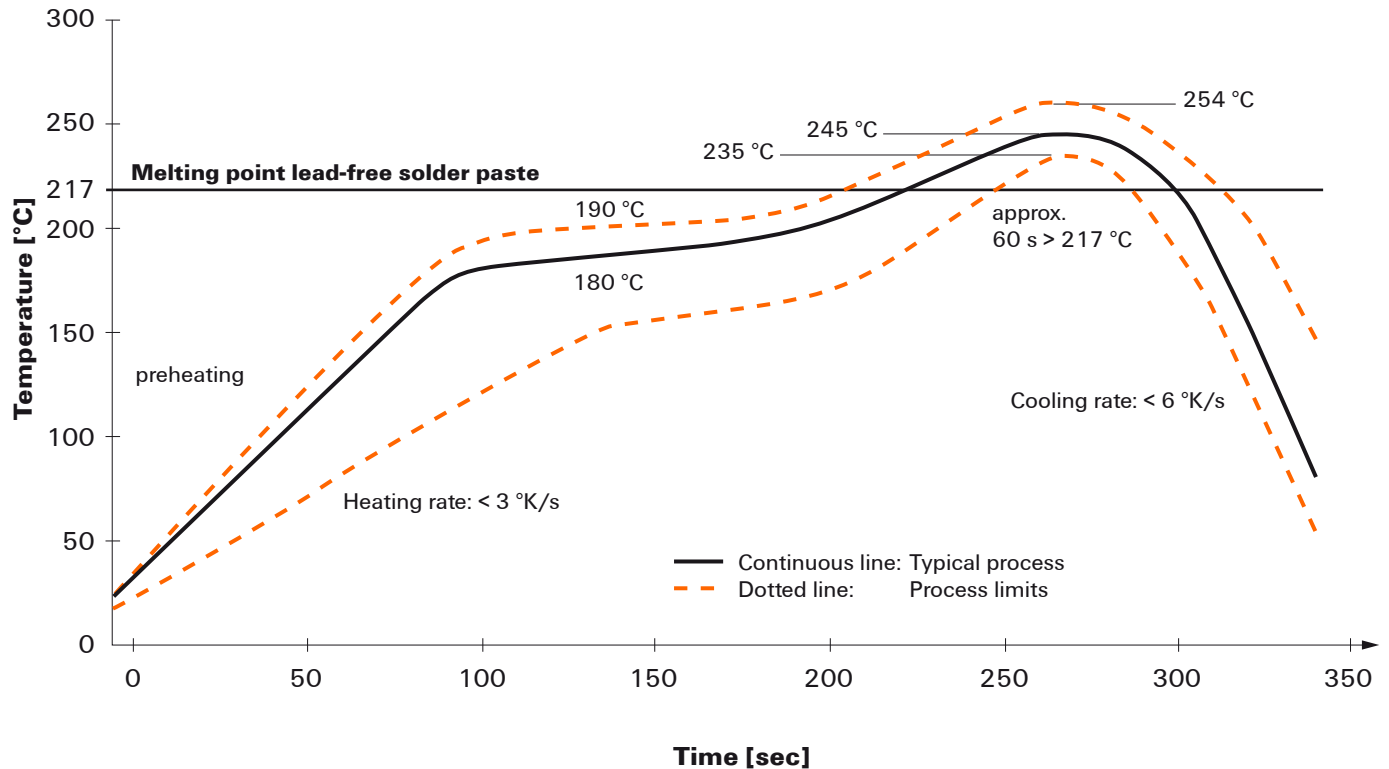
D-32758 Detmold

Germany

Fon: +49 5231 14-0

Fax: +49 5231 14-292083

www.weidmueller.com



Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3\text{K/s}$. In parallel the solder paste is 'activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at $\geq -6\text{K/s}$ solder is cured. Board and components cool down while avoiding cold cracks.